

## PHT Inc.

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# Automatic Wafer Demounter PWD2010



## **Automatic Wafer Demounter**

#### **Summary**

This is an automatic wafer peeling device after wire-saw (slice). By setting the ingot adhered to the plate fixture on the input side, it is a system that automatically performs rough washing, wafer peeling, wafer leaf washing, drying, and cassette storage. The peeled plate fixture is discharged on the unloader side. Peeling is performed one by one using a hot air heating method. The peeled wafers are washed by the leaf method. After two-fluid high-pressure cleaning, scrub cleaning, rinse cleaning, water absorption roller drying, and slit nozzle drying, each wafer is stored in the cassette of the unloader part by a horizontal multi-joint robot. Storage can be selected from the upper or lower stage of the cassette (25 pieces). The storage cassette can hold up to 6. It supports OHT transport.

#### **Features**

- Unique control for slide mechanism.
- Automated the cleaning process after wafer peeling, which was difficult.
- It automatically performs everything from cleaning the wafer cut with a wire saw in leaves after peeling from the beam to storing it in a cassette.
- Realizes low running cost.
- Design can be adapted to your ingot lifter.
- Loader ID reader can be added as an option.
- RFID function can be added to the unloader carrier part as an option.

### **Case Studies**

I want to automate the manual peeling process and manage the information of the wafers.

| Model            | Automatic Wafer Demounter PWD2010   | Automatic Wafer Demounter PWD2020 |
|------------------|---|-----------------------------------|
| Version          | Туре0 Туре1   |                                   |
| Compatible Size  | φ4 - 8″   | φ12″                              |
| Storage          | Cassette (25 sheets included)   |                                   |
| Storage Cassette | Up to 6 (subject to consideration)  |                                   |
| Plate Fixture    | NTC-made & MB-made  |                                   |
| Drive Method     | Motor Drive (Servo)   |                                   |
| Safety Mechanism | Presence or absence of cassette, presence or absence of wafer, overload detection, abnormal alarm, emergency stop.                |                                   |
| Power Supply     | AC200V, 100A  |                                   |
| Weight           | Approximately 5,000kg   |                                   |
| Option           | ID reader in the loader section, RFID in the unloader section, wafer inversion, storage in multiple cassettes, area sensors, etc. |                                   |